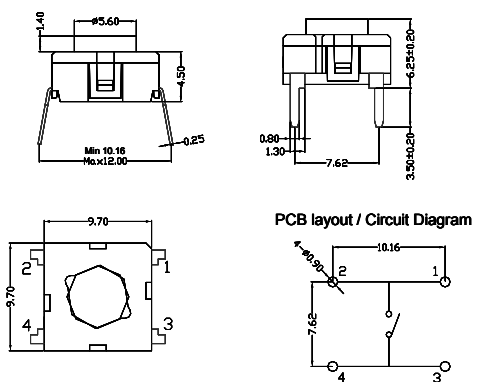
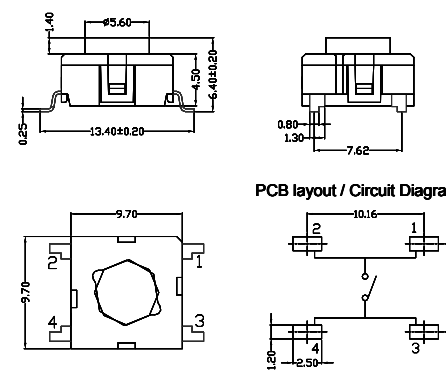
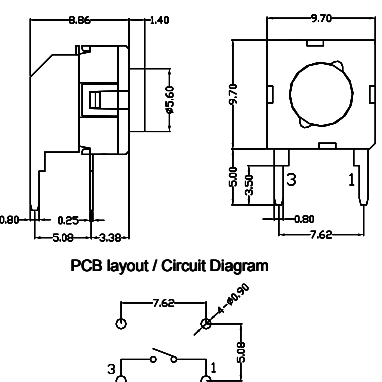
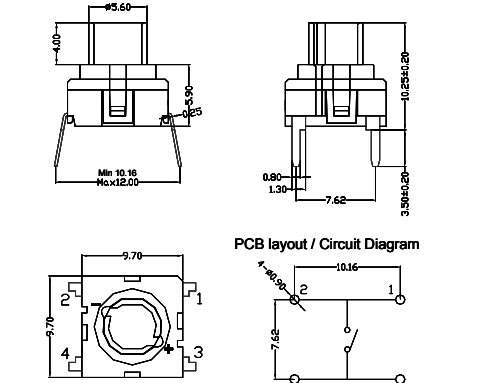
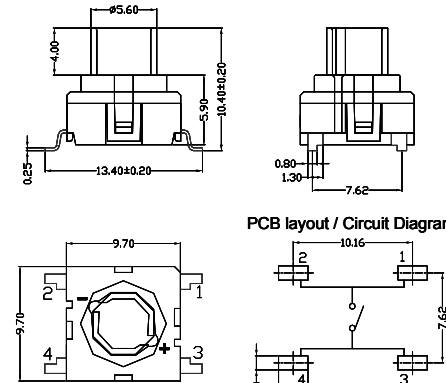
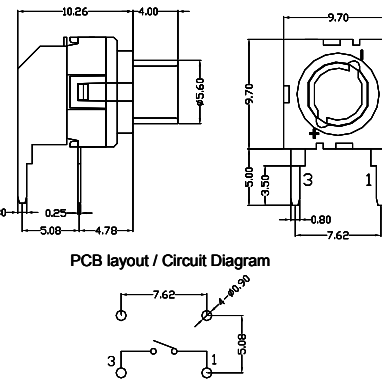


## Technical Data

Through-hole / SMD / Right angle  
 single pole / momentary  
 50mA/24VDC  
 10,000,000 operations life time (Max.)  
 Meet IP67  
 Contact resistance : 30mΩ  
 Insulation resistance : > 10MΩ  
 Basic temp.: -40/+115 °C  
 High temp.: -40/+160 °C  
 Max actuation Force : 100N for 10 Sec.  
 Push force : 400N +/- 100N

PATENTED



3CH/T	3CS	3CY
<p>Dimensions ( through-hole )</p> 	<p>Dimensions (SMD)</p> 	<p>Dimensions ( right-angle )</p> 
3FH/T	3FS	3FY
<p>Dimensions ( through-hole )</p> 	<p>Dimensions (SMD)</p> 	<p>Dimensions ( right-angle )</p> 

## How to order

**3 C**

**TM series**

**3C**

**3F**

**Mounting**

- H** through-hole
- T** through-hole reflow
- S** surface mount
- Y** right angle

**1 D**

**CAP**



**Colour codes**

- 00 Blue
- 02 Green \*
- 03 Grey
- 04 Yellow \*
- 06 White
- 08 Red
- 09 Black

- 1 Through-hole : base & Actuator with Blue color
- 2 SMD : base & actuator with Black color
- 3 Cover : with White color
- 4 \* CAP MOQ: 2000pcs per order  
CAP color cross with MEC color by RAL no.

## Technical Data

PATENTED

Through-hole / SMD / Right angle  
 single pole / momentary  
 50mA/24VDC  
 10,000,000 operations life time (Max.)  
 Meet IP67  
 Contact resistance : 30mΩ  
 Insulation resistance : > 10MΩ  
 Basic temp.: -40/+115 °C  
 High temp.: -40/+160 °C  
 Max actuation Force : 100N for 10 Sec.  
 Push force : 400N +/-100N  
 Available With LED



4FH/T	4FS	
<p>Dimensions ( through-hole )</p>	<p>Dimensions (SMD)</p>	<p>Material colors :</p> <ol style="list-style-type: none"> <li>Through-hole : base &amp; Actuator with Blue color</li> <li>SMD : base &amp; actuator with Black color</li> <li>Cover : with White color</li> </ol>
<p>6FH/T</p>	<p>6FS</p>	<p>6FY</p>
<p>Dimensions ( through-hole )</p>	<p>Dimensions (SMD)</p>	<p>Dimensions ( right-angle )</p>

## How to order

4 F

1 F

### TM series

4F  
6F

### Mounting

H through-hole  
 T through-hole reflow  
 S surface mount  
 Y right angle

### LED colour codes

01 blue  
 21 green  
 42 yellow  
 61 white  
 82 red  
 2142 green/yellow  
 8221 red/green  
 8242 red/yellow

### CAP



### Colour codes

00 Blue  
 02 Green \*  
 03 Grey  
 04 Yellow \*  
 06 White  
 08 Red  
 09 Black

\* CAP MOQ: 2000pcs per order  
 CAP color cross with MEC color by RAL no.

## Electrical Specifications

Contact resistance	< 30m Ω- typ. 10m Ω
Insulation resistance	> 10M Ω
Recommended load	0.5μ-50mA 24VDC
Contact bounce	<2mS- typically 0.5mS

## Mechanical Specifications

Standard actuation force (switch)	3.0N typ.
Max. actuation force without cap	100N for 10sec.
Key travel (switch)	1 mm
Life time (switch)	10.000.000 cycles(Max.)

## Temperature Range

Basic temperature	-40/+115 °C
Working temperature	Min. -40°C Max. +160°C
Storage temperature	Min. -40°C Max. +160°C

## Soldering IEC 68-2-20

Infrared, vapour phase, wave-max. 240°C for max. 40 sec. or max. 260°C for max. 30 sec. Soldering Iron- max. 350°C for max. 3 sec. Flux tight.

## Environmental Endurance IEC 68-2-3

Temperature	+40°C
Humidity	93% RH
Duration	21 Days

## Temperature Cycling IEC 68-2-14

Temperature limit	Min. -55°C - Max. +85°C
Number of cycles	200
Exposure time at each temperature	10 min
Recovery time before measurements	16 hrs.
Sealing IEC 529	meet IP-67

## Vibration Test : meet IEC 68-2-6

## Soldering

### (1)Hand Soldering

Soldering iron 30W or under at 350°C for 3 sec max or at 270°C for 5 sec max.

### (2)Reflow Soldering

260°C±5°C within 30 sec for reflow. In-line or Batch system.

### (3)Wave soldering

For lead free wave solder simulation of typical components. the solder bath temperature Shall be maintained to 275°C. The hold time in the solder shall be 10 +2/-0 seconds.

※Any flux enters the switch may influence contact function .

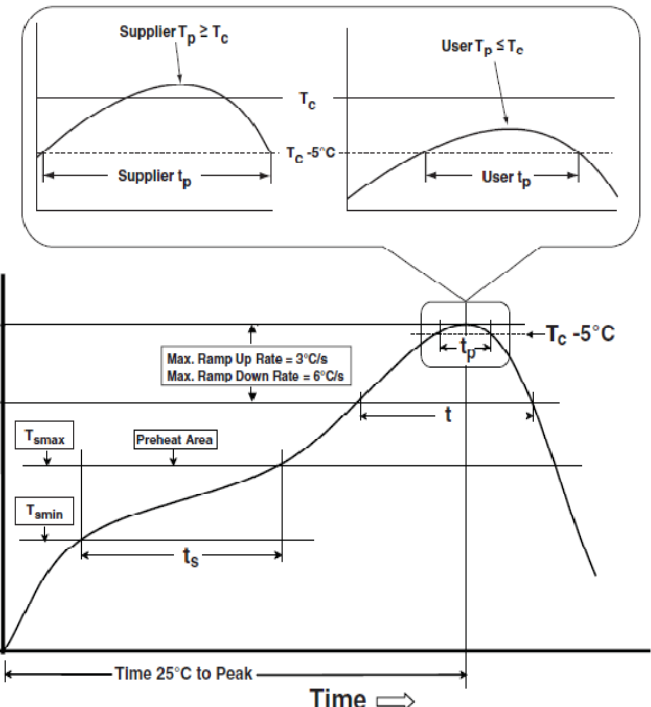
\* All CAP un-allow pass through Soldering proccs.

## Classification Reflow Profiles

Profile Feature	Pb-Free Assembly
<b>Preheat &amp; Soak</b>	
Temperature Min ( $T_{smin}$ )	150 °C
Temperature ( $T_{smax}$ )	200 °C
Time( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max.
Liquidous temperature ( $T_L$ )	217°C
Time at liquidous ( $t_L$ )	60-150 seconds
Peak package body temperature( $T_p$ )*	For user $T_p$ must not exceed the Classification temp: 260°C For suppliers $T_p$ must equal or exceed Classification temp: 260°C
Time ( $t_p$ ) within 5 °C of the specified classification temperature ( $T_c$ )	30 seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

\*Tolerance for peak profile temperature( $T_p$ ) is defined as a supplier minimum

## Reflow Soldering Standard Conditions



Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Note 2: Time within 5 °C of actual peak temperature ( $t_p$ ) specified for the reflow profiles is a "supplier" minimum and "user" maximum.